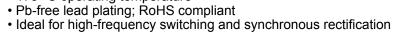


MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

- Dual-side cooled package with lowest junction-top thermal resistance
- N-channel, normal level
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 Very low reverse recovery charge (Qrr)
 175 °C operating temperature

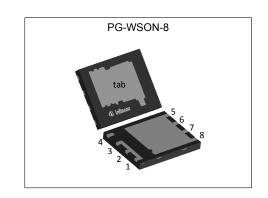


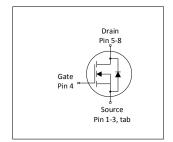
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	150	V
R _{DS(on),max}	9.3	mΩ
I _D	89	A
Qrr	58	nC











Type / Ordering Code	Package	Marking	Related Links
BSC093N15NS5SC	PG-WSON-8	093N15SC	-

OptiMOS[™] 5 Power-Transistor, 150 V BSC093N15NS5SC



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OptiMOS[™] 5 Power-Transistor, 150 V BSC093N15NS5SC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damamastan	Ols al	Values			11	Note / Took Oom did on
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	89 63	А	T _C =25 °C T _C =100 °C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	356	Α	T _C =25 °C
Avalanche energy, single pulse ³⁾	E AS	-	-	130	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	167	W	T _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Symbol	Values			l lmi4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.54	0.9	K/W	-	
Thermal resistance, junction - case, top	R _{thJC}	-	0.36	0.72	K/W	-	
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁴⁾	R _{thJA}	-	-	50	K/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

²⁾ See Diagram 3 for more detailed information

³⁾ See Diagram 13 for more detailed information

⁴⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

OptiMOS[™] 5 Power-Transistor, 150 V BSC093N15NS5SC



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Danamatan	0		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	3.0	3.8	4.6	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =107 μ A	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I_{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	7.6 8.4	9.3 10.1	mΩ	V _{GS} =10 V, I _D =44 A, V _{GS} =8 V, I _D =22 A	
Gate resistance ¹⁾	R _G	-	0.9	1.4	Ω	-	
Transconductance	g fs	34	67	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 44 \text{ A}$	

Table 5 Dynamic characteristics

Davamatav	Or made all		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	2430	3230	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	604	803	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	15	26	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	14	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	4.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	14.4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	3.8	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =3 Ω

Table 6 Gate charge characteristics²⁾

Parameter	C:h a l	Values			11	Nata / Tank Candikian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	14	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	6.8	10.2	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	13.4	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	33	40.7	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.7	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	91	121	nC	V _{DD} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test $^{2)}$ See "Gate charge waveforms" for parameter definition

OptiMOS[™] 5 Power-Transistor, 150 V BSC093N15NS5SC

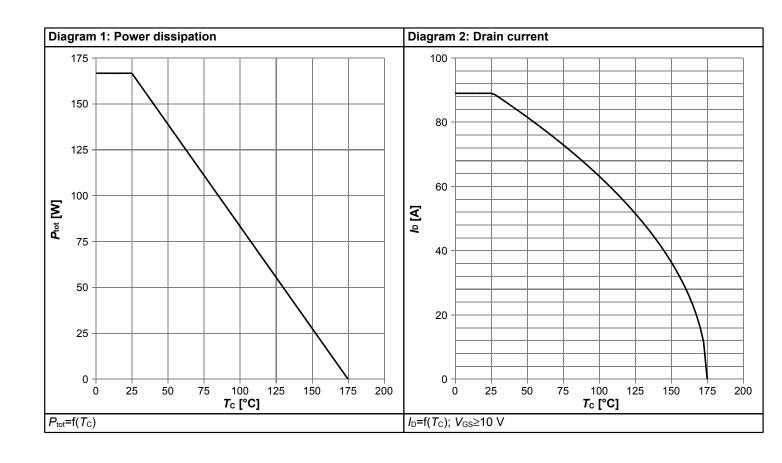


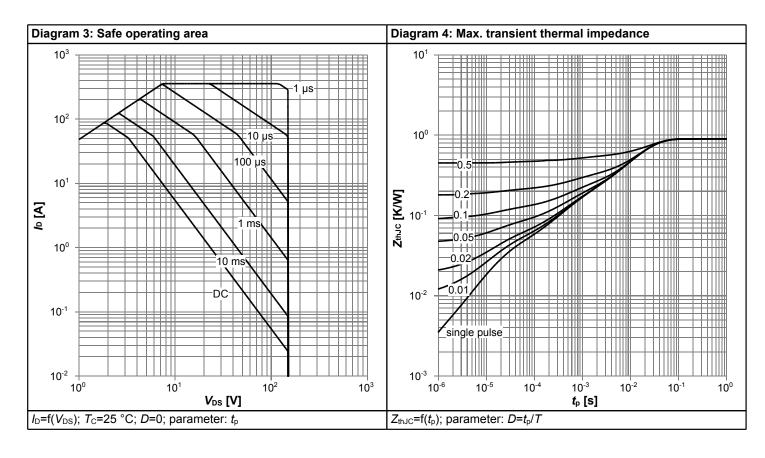
Table 7 Reverse diode

Damamatan	Combal		Values			Note / Took Considition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	Is	-	-	89	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	356	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.88	1.2	V	V _{GS} =0 V, I _F =44 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	49	98	ns	V _R =75 V, I _F =44, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	58	116	nC	V _R =75 V, I _F =44, di _F /dt=100 A/μs

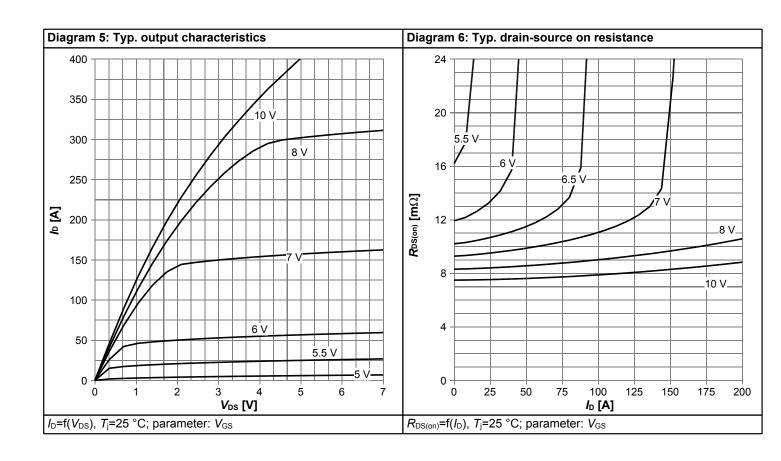


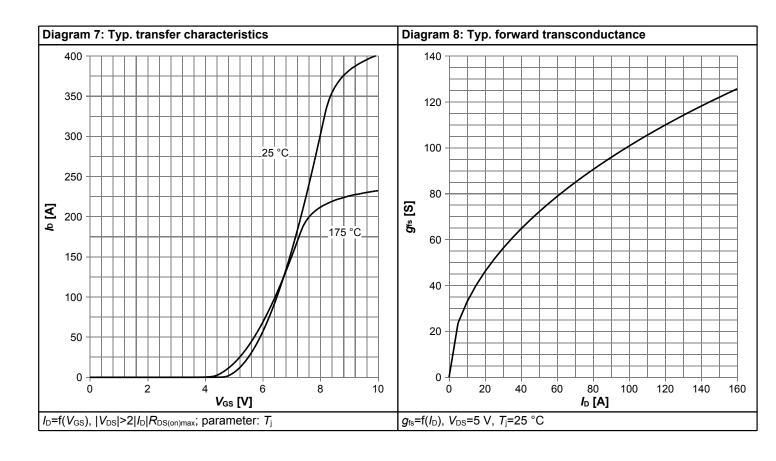
4 Electrical characteristics diagrams



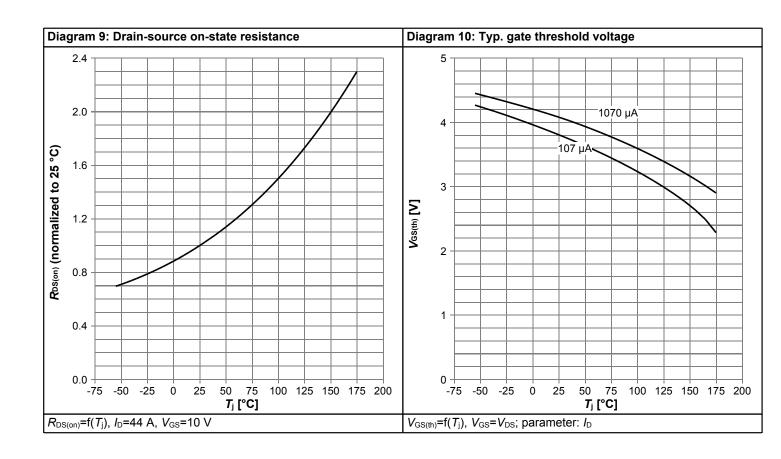


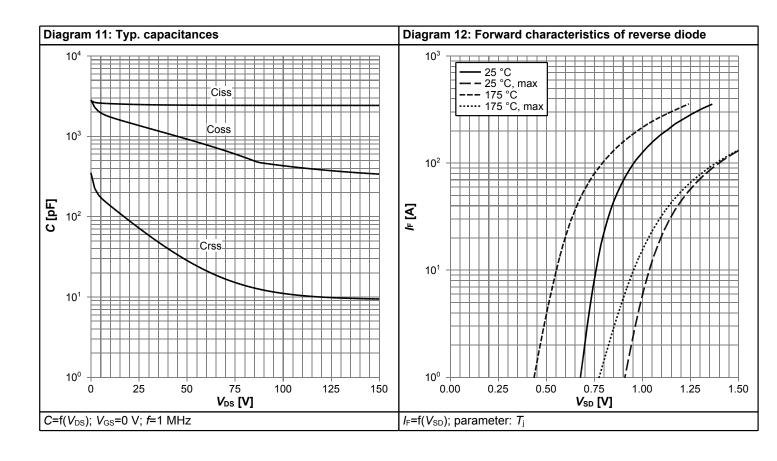




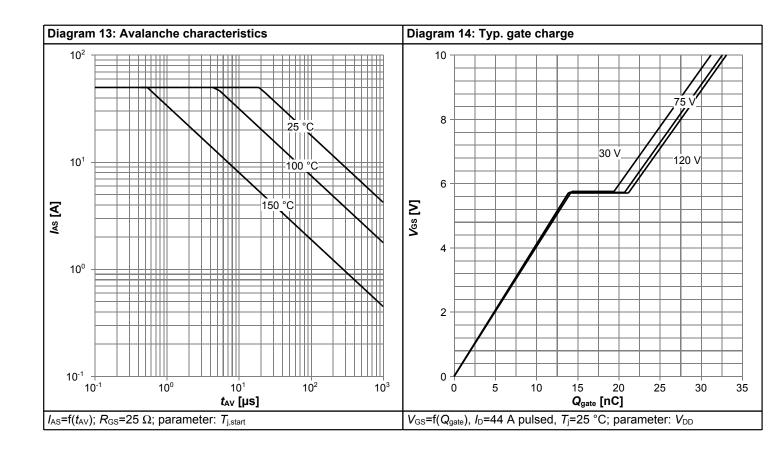


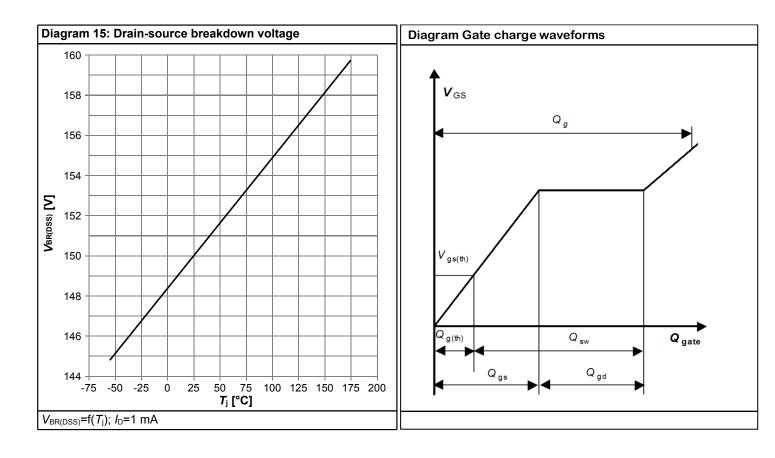






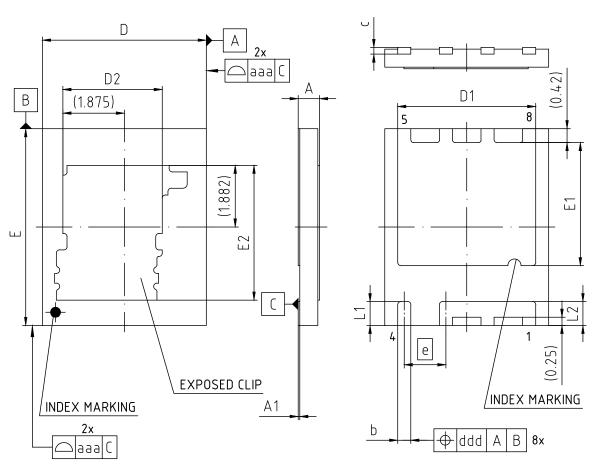








5 Package Outlines



DIMENSIONS DOES NOT INCLUDE MOLD FLASH OR MOLD PROTRUSIONS.

DIMENSION	MILLIMETERS						
DIMENSION	MIN.	MAX.					
Α	-	0.75					
A1	-	0.05					
b	0.35	0.45					
С	0.203						
D	4.95	5.05					
D1	4.11	4.31					
D2	3.03						
E	5.95	6.05					
E1	3.66 3.86						
E2	4.11						
е	1.27						
L1	0.675 0.775						
L2	0.625 0.825						
aaa	0.05						
ddd	0.10						

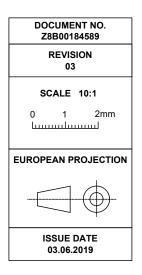


Figure 1 Outline PG-WSON-8, dimensions in mm

OptiMOS[™] 5 Power-Transistor, 150 V BSC093N15NS5SC



Revision History

BSC093N15NS5SC

Revision: 2022-10-07, Rev. 2.1

Previous Revision

Trovidue Novicien								
Revision	Date	Subjects (major changes since last revision)						
2.0	2022-08-29	Release of final version						
2.1	2022-10-07	Update "Features"						

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